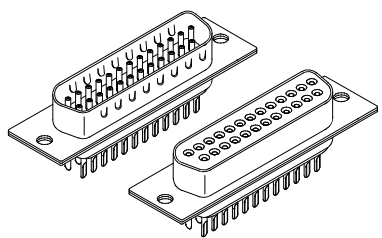
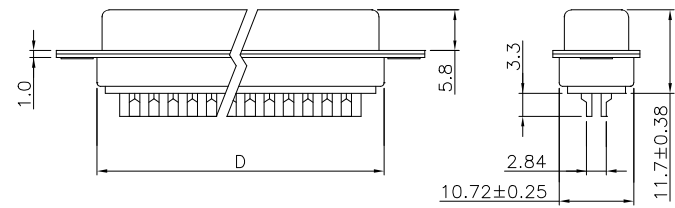
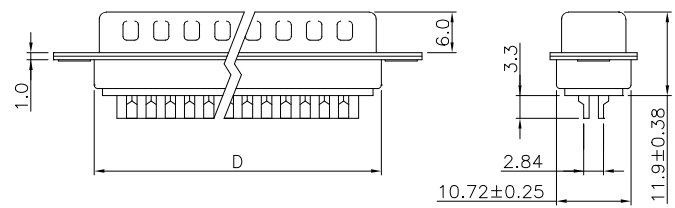
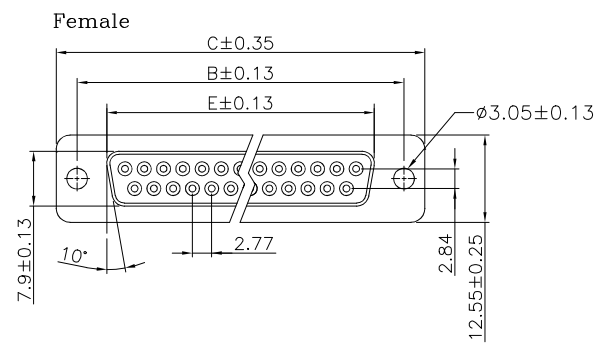
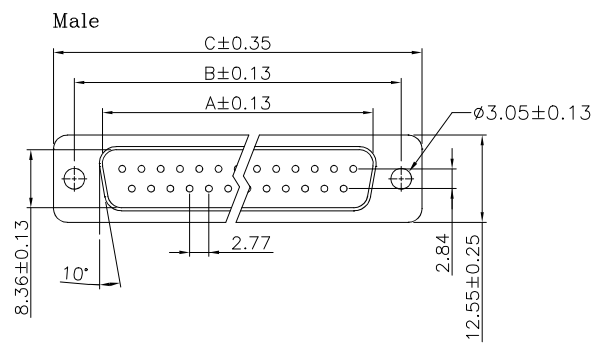


REV.	SPECIFICATION	ECN NO.	APPD.



**Material:**  
Housing: PBT, UL94V-0.  
Contacts: Brass, Gold Plated on Contact Area and 80~100u"  
Min Tin Plated on solder tail over Nickel 30u" Min  
or Gold Plated over Nickel 30u" Min.  
Shell: Steel, 80u" Nickel Plated over 40u" Copper.  
**Electrical Characteristics:**  
Current Rating: 1 AMP.  
Dielectric Withstanding Voltage: AC 1000V.  
Insulation Resistance: 1000MΩ min.  
Contact Resistance: 20mΩ max.  
Operating Temperature: -55°C~+105°C.  
**\*RoHS Compliant**



7907- xx M T B C 00 A  
Series ————  
Positions ————  
M: Male  
F: Female  
B: Black  
U: Blue  
W: White  
A: Tray Package  
00: G/F  
C: Selective Gold Plated  
G: Gold Plated

Position	Dimension				
	A	B	C	D	E
09	16.92	24.99	30.81	19.28	16.33
15	25.25	33.32	39.14	27.51	24.66
25	38.96	47.04	53.04	41.30	38.38
37	55.42	63.50	69.32	57.40	54.84

<b>Tolerances</b>	<b>Dwg. No.</b>	7907D03001	<b>Title:</b>	
x = ±0.5	<b>Projection</b>		7907 Series	
.x = ±0.25	<b>Unit</b>	mm	<b>Scale</b>	1:1
.xx = ±0.15	<b>Drawn By</b>	Martin 04/06'22	D-SUB Solder Cup Type	

**OUPIIN**  
**OUPIIN ELECTRONIC(KUNSHAN) CO., LTD.**  
P/N: 7907-xxMTBC00A & 7907-xxFTBC00A  
**SHEET** 1/1 **Ver.No.** A8